Dual-Ouputs 6-A Buck Converter with Integrated DCP Scheme

1 Description

The SC8112 is a synchronous dual-output ports buck converter with a wide input voltage from 4.6V to 36V. The SC8112 regulates the output voltage at a fixed 5V or customized voltage by setting the divider resistor. It also provides high accurate output current limit. The converter enters Constant Current (CC) Mode in case any of the two output channels reaches the setting current limit. The total output power can be programmed by a resistor, which makes it easy for constant power (CP) control.

The SC8112 adopts programmable line drop compensation, programmable frequency setting and operating modes selection for PWM and PFM With minimum external components, maximum functions can be achieved for user's different applications.

The SC8112 also supports full protections including under voltage protection, over voltage protection, short current protection and auto-restart, over temperature protection.

The SC8112 adopts 32 pin QFN 5x5 package

3 Applications

- Car Charger
- Multi-Ports Wall Charger
- Hub
- Industrial applications

2 Features

- Wide input operating voltage from 4.6V to 36V
- 11mΩ/27mΩ Low Rdson Internal Power MOSFETs
- Max output capacity with 5V/6A
- 100% duty cycle operation
- Low quiescent current
- High side output current sense
- ±5% output current limit accuracy
- Programmable output power limit
- Programmable line drop compensation
- Build-in DP/DM for BC 1.2 DCP scheme
 - BC1.2 DCP Mode
 - Divider Mode
 - 1.2V/1.2V Mode
- PFM/PWM mode selection
- Adjustable frequency 80kHz to 600kHz
- Hiccup and auto-restart
- Full protection of UVLO, OVP, OCP, OTP

4 Device Information

ORDER NUMBER	PACKAGE	BODY SIZE
SC8112QDJR	32 pin QFN	5 mm x 5 mm x 0.75 mm



5 Typical Application Circuit

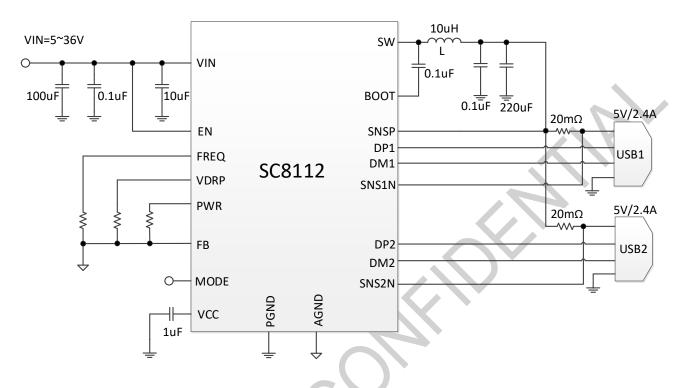
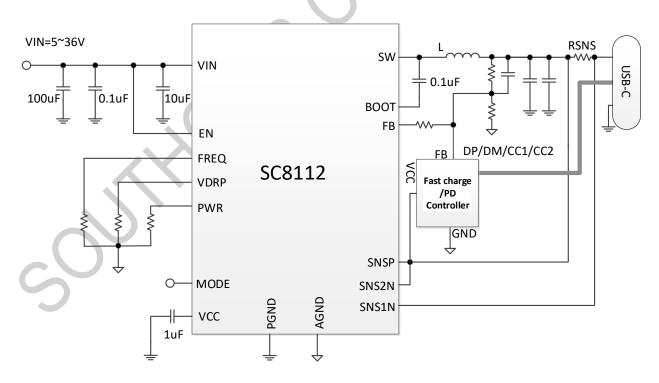


Figure. 1 Typical Application Circuit with 5V4.8A Dual-Outputs







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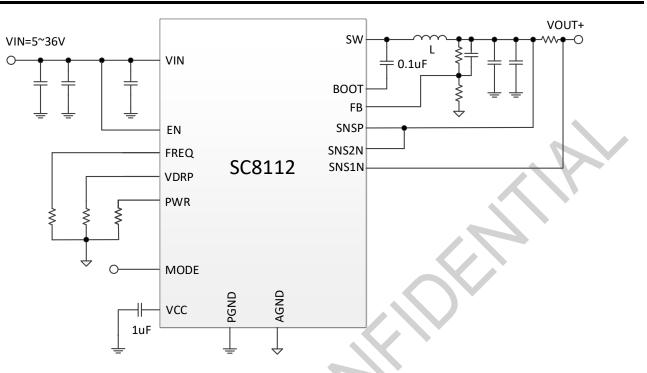
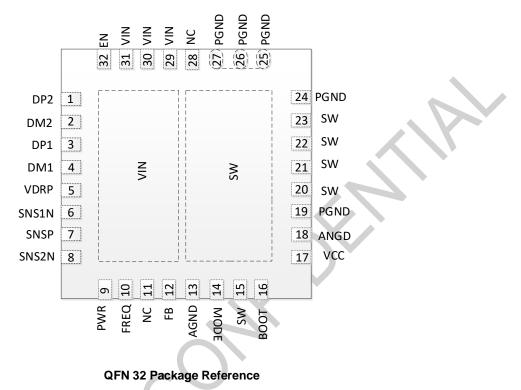


Figure.3 Typical Application Circuit with general purpose BUCK converter





6 Terminal Configuration and Functions



(Top View)

TERMI	TERMINAL		DESCRIPTION
NUMBER	NAME	I/O	DESCRIPTION
1	DP2	I/O	D+ data line to USB connector 1, used for hand-shaking with portable devices.
2	DM2	I/O	D- data line to USB connector 1, used for hand-shaking with portable devices.
3	DP1	1/0	D+ data line to USB connector 2, used for hand-shaking with portable devices.
4	DM1	I/O	D- data line to USB connector 2, used for hand-shaking with portable devices.
5	VDRP	0	Line drop compensation configuration pin. Setting the line compensation slope by connecting a resistor to AGND
6	SNS1N	I	Negative end of output 1 current sense amplifier.
7	SNSP	I	Positive end of output current sense amplifier/ Output voltage sense.
8	SNS2N	I	Negative end of output 2 current sense amplifier.
9	PWR	I	Output power limit pin. Setting the output power limit by connecting a resistor to AGND
10	FREQ	I	The operation frequency is programmed by a resistor between this pin and AGND.



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11	NC		Keeping floating (This pin is connected to VIN from internal metal frame)
12	FB	I	Output voltage feedback. Connect the center of two divider resistor to program the output voltage. Output voltage be configured for fixed 5.1V with FB pin connected to AGND.
13,18	AGND	I/O	Analog Ground.
14	MODE	I	Mode selection pin. Logic high level sets the device working in PWM mode; logic low level or floating sets the device working in PFM mode.
16	BOOT	PWR	Connect a capacitor between BT and SW to bootstrap a voltage to provide the bias for high side MOSFET driver.
17	VCC	PWR	Output of internal regulator to provide 5.2V voltage for the bias voltage of internal gate drivers. Connect a 1 μ F ceramic capacitor from VCC to PGND pin.
15, 20~23	SW	PWR	Switching node.
19, 24~27	PGND	PWR	Power ground.
28	NC		Keeping floating (This pin is connected to SW from internal metal frame)
29~31	VIN	I	Input node of Buck. Connect a 10 µF ceramic capacitor from VIN to PGND pin.
32	EN	Ι	Enable logic input. Logic high level enables the device and logic low level disables the device.



7 Specifications

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

		MIN	МАХ	UNIT
	VIN, EN , SNS1N, SNS2N, SNSP	-0.3	42	V
Voltage range at	SW	-1	42	V
terminals ⁽²⁾	FB, DP1, DM1, DP2, DM2, VCC, MODE, FREQ, PWR, VDRP,	-0.3	6.5	V
	BOOT	-0.3	50	V
	Operating Junction, T _J	-40	150	°C
	Storage temperature range, T _{stg}	-65	150	°C
Temperature Range	Continuous power dissipation (TA=25°C), P _D ⁽³⁾		3.2	W
	Junction to ambient thermal resistance, $T_{\Theta JA}^{(3)}$	39		°C/W
	Junction to case (top) thermal resistance, Teuc ³⁾	18		°C/W

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to network ground terminal.

(3) Measured on JESD51-7, 4-layer PCB.

7.2 Handling Ratings

PARAMETER	DEFINITION	MIN	MAX	UNIT
	Human body model (HBM) ESD stress voltage ⁽²⁾ for DP/DM pin	-8	8	kV
ESD ⁽¹⁾	Human body model (HBM) ESD stress voltage for other pins	-2	2	kV
	Charged device model (CDM) ESD stress voltage ⁽³⁾	-750	750	V

(1) Electrostatic discharge (ESD) to measure device sensitivity and immunity to damage caused by assembly line electrostatic discharges into the device.

(2) Level listed above is the passing level per ANSI, ESDA, and JEDEC JS-001. JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(3) Level listed above is the passing level per EIA-JEDEC JESD22-C101. JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

		MIN	ТҮР	МАХ	UNIT
VIN	Input voltage range	5		36	V
Vout	Output voltage range		5		V
CIN	Input Capacitance	30	100		μF
Соит	Output capacitance	80	220	680	μF
L	Inductance	10	15	22	μH



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R _{SNS1/2}	Current Sensing Resistor		20		mΩ
fsw	Operating frequency range	80	120	600	kHz
TJ	Operating junction temperature	-40		125	°C

(1) The recommend operation conditions are based on 5V4.8A dual outputs application.

7.4 Electrical Characteristic

 $T_{J}\text{=}~25^{\circ}\text{C}$ and V_{IN} = 12V, V_{OUT} = 5.1V, unless otherwise noted.

PARAMETE	ER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
SUPPLY VO	DLTAGE					
V _{IN}	Operating voltage		4.6		36	V
		Rising edge		4.35	4.5	V
Vin_uvlo	Under voltage lockout threshold	Falling edge		4.2	4.4	V
lq	Quiescent current into VIN	EN= high, no switching		300		μA
Isd	Shutdown current into VIN	EN = low		32	4	μA
OUTPUT						-
			3		36	V
Vout	Operating voltage	FB connected to GND	5.05	5.1	5.15	V
$V_{\text{FB}_{\text{REF}}}$	FB reference voltage		1.208	1.22	1.232	V
Rui	Upper divider resistor of internal FB	FB connected to GND		78		kΩ
IVDRP_max	Max Line drop compensation current			1.5		μA
V _{Drop_max}	Max internal Line drop compensation	FB connected to GND		120		mV
VCC AND D	DRIVER					
Vcc	VCC clamp voltage		4.9	5.2	5.5	V
Ivcc_lim	VCC current limit	V _{CC} = 5.2V	40			mA
DT1	Dead time for HD off to LD on	V _{CC} = 5.2V		25		ns
DT2	Dead time for LD off to HD on	V _{CC} = 5.2V		25		ns
POWER SV	итсн		I			
D	High-side MOSFET on-resistance	VCC=5.2V		27		mΩ
R _{DS(on)}	Low-side MOSFET on-resistance	VCC=5.2V		11		mΩ
CURRENT	LIMIT					
I _{LIM_Peak}	Internal peak current limit		11			Α
VLIM_OUT	Output current limit threshold	RSNS=20mΩ	54.4	56	58.6	mV
SWITCHING	G FREQUENCY					
			80		600	kHz
fsw Switching frequency		R _{FREQ} = Floating		120		kHz
SOFT STAF	RT	1	1			4
tss	Internal soft-start time	VOUT from 10% to 90%		5	8	ms
BC1.2 DCP	MODE	1	1			

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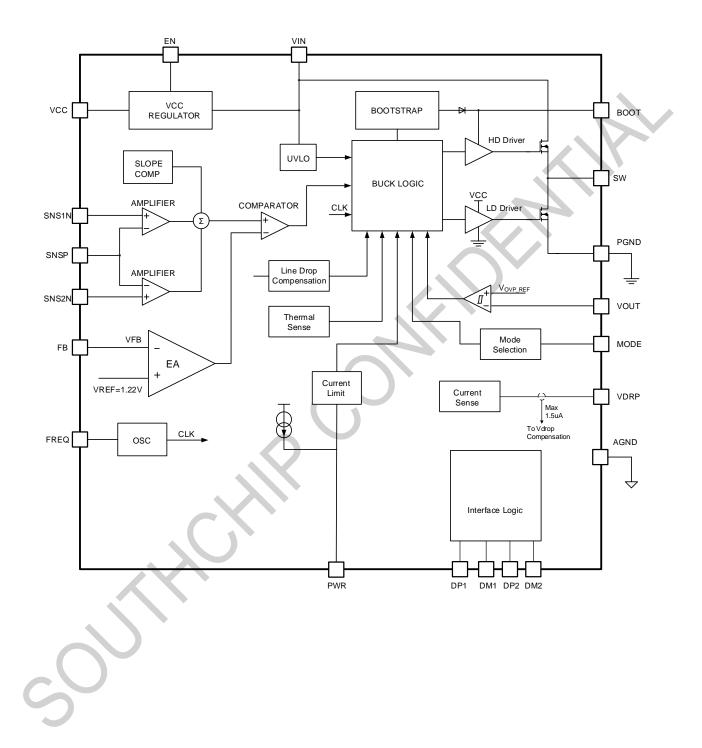
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$R_{\text{DPM}_{\text{short}}}$	DP/DM short resistor		5	10	20	Ω
	IODE	1				
V _{DP_divider}	DP output voltage		2.57	2.75	2.84	V
$V_{DM_divider}$	DM output voltage		2.57	2.75	2.84	V
Z _{DP_divider}	DP output impedance		24	30	36	kΩ
Z _{DM_divider}	DM output impedance		24	30	36	kΩ
1.2V/1.2V	MODE					V
V _{DPM_1.2V}	DP/DM output voltage		1.1	1.2	1.3	V
Z _{DP_1.2V}	DP output impedance		70	100	130	kΩ
Z _{DM_1.2V}	DM output impedance		70	100	130	kΩ
LOGIC CO	LOGIC CONTROL					
V _{EN_R}	EN rising threshold				1.2	V
$V_{\text{EN}_{\text{F}}}$	EN falling threshold		0.9	1.0	1.1	V
VMODE_L	MODE logic low voltage		0.4			V
V_{MODE_H}	MODE logic high voltage				1.2	V
PROTECT	ON					
OVP	Output over voltage protection	FB connected to feedback network	108%	110%	112%	
		FB connected to GND	5.5	5.55	5.61	V
V _{HICP}	Hiccup trigger threshold voltage			2.0		V
THICP_ON	On time of Hiccup Mode	VOUT<2.0V	15	20	25	ms
THICP_OFF	Off time of Hiccup Mode	VOUT<2.0V	400	500	600	ms
THERMAL	SHUTDOWN		ı			
	Thermal shutdown temperature ⁽¹⁾			165		°C
Tsd	Thermal shutdown hysteresis (1)			15		°C

(1) Guarantee by design



8 Functional Block Diagram



9 Detailed Description

The SC8112 is a dual-output synchronous buck converter with a wide input voltage range. The SC8112 is configured to provide a fixed 5-V or customized output voltage programmed by FB pin. Each channel offers max 3A continuous output capacity with $\pm 5\%$ current limit accuracy.

The SC8112 operates in a fixed frequency current mode control to regulate the output voltage in Constant Voltage (CV) mode. If output current reaches its limit, the SC8112 enters Constant Current (CC) mode while output voltage drops. If the output current still goes larger, SC8112 enters hiccup as short circuit protection when output voltage is lower than 2V. The line drop compensation, power limitation and operating frequency are programmable for different user's application. The internal loop compensation simplifies the design process and save the external components.

The SC8112 works in two different modes: PFM and PWM mode. In PFM mode, high efficiency can be achieved in light load condition. In PWM mode, the switching frequency is same both for light load and heavy load conditions and output ripple can be reduced.

9.1 Feature Description

9.1.1 Enable and Programmable UVLO

The SC8112 has an enable control pin EN: pulling it high enables the IC and pulling it low disables the IC. Connect EN to VIN for automatic startup.

EN pin can also be reused for VIN under voltage protection. Connecting the center tape of the divider resistors between VIN and GND programs the VIN under voltage threshold and restart voltage, as shown in Figure. 4

The VIN under voltage threshold can be calculated as the following equation.

$$V_{IN_LOW} = 1.0V \times \left(1 + \frac{R_{IN1}}{R_{IN2}}\right)$$

When the input voltage is higher than the startup threshold, the SC8112 goes back to normal operation.

$$V_{IN_HIGH} = 1.2V \times \left(1 + \frac{R_{IN1}}{R_{IN2}}\right)$$

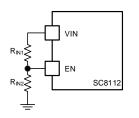


Figure.4 UVLO Threshold Programming

9.1.2 Startup and Shutdown

The SC8112 integrates an internal circuit that controls the ramp up of output voltage during start-up and prevents the converter from the large inrush current. During the startup phase, the internal soft-start circuit increases the voltage on FB pin gradually so that the output voltage slope follows the FB pin voltage slope until the target voltage is reached.

9.1.3 Mode Selection

The SC8112 integrates two different operating modes: PWM mode and PFM mode.

In PWM mode, SC8112 always works in constant frequency for the whole load range, which can achieve the best output voltage performance. The efficiency is low since negative inductor current appears at light load condition.

In power save mode with pulse frequency modulation (PFM), the efficiency can be improved at light load condition while output voltage ripple can be a little larger compared with PWM operation.

9.1.4 Output Voltage Setting

The SC8112 can be configured for two fixed 5.05V output ports with FB pin connected to GND. The output voltage can also be configured for customized values by using external feedback resistors. The FB status is only detected when IC is powered up, so the FB configuration setting is latched and cannot be changed until SC8112 is powered down and restart again.

If alternative output voltage is required, the following equation can be used to calculate the divider resistor.

$$VOUT = V_{FB_REF} \times \left(1 + \frac{R_U}{R_D}\right)$$

Where:

V_{FB_REF} = Internal reference voltage 1.22V

 R_U and R_D = Resistor divider at FB connected to VOUT and AGND.



9.1.5 Line Drop Compensation

The SC8112 is capable of compensating the output voltage drop, caused by a long trace, to keep a fairly constant loadside voltage. The line drop compensation is adjusted by the internal current source, which sinks a certain current from FB to GND. The current slop can be adjusted by VDRP pin with a resister connected to GND (1.5uA, max).

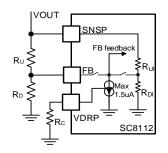


Figure.5 Line Drop Compensation diagram

The compensation voltage is calculated by the following formulas:

$$\Delta V_{OUT} = \frac{2.5 \times R_{U}}{R_{C}} \times V_{SENSE}$$
$$V_{SENSE} = I_{OUT} \times R_{SENSE}$$

Where:

 R_U is the upper resistor of FB divider. The maximum compensation voltage: $\Delta V_{OUT-MAX} = 1.5 \times R_U$.For FB pin connected to GND application, R_{UI} is 78 K Ω and the maximum compensation voltage $\Delta V_{OUT-MAX}$ is 117mV.

R_C =VDRP setting resistor.

 V_{SENSE} is the output current sampling voltage (54mV, max).In dual outputs application, the device selects the larger one to compensate the line drop.

I_{OUT} = output voltage

R_{SENSE} = output current sampling resistor

Here are 2 typical applications with different R_C:

Example 1, FB pin connected to GND application:

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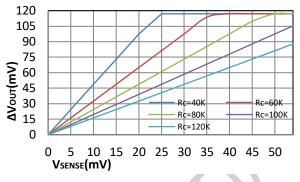


Figure.6 ΔVout vs. Vsense(Rui=78 KΩ)

Example 2, FB pin is set with 100K upper resistor:

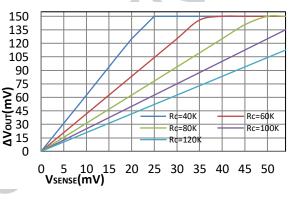


Figure.7 ΔVout vs. Vsense(Ru=100 KΩ)

Using proper R_C/R_U user can set the compensation slop and the maximum amplitude. The line drop compensation amplitude increases linearly as the load current increasing.

9.1.6 Switching Frequency

The switching frequency can be set by a resistor between FREQ pin and GND. Figure.8 shows the relationship between operating frequency and resistor value.

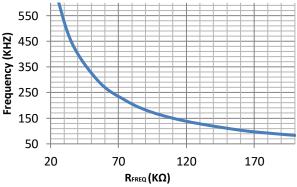


Figure.8 Switching Frequency vs. Setting Resistor



For minimal external components and simplifying the design process, the SC8112 also supports 120-kHz operating frequency if FREQ pin is floating.

9.1.7 Output Power Limit

The output power limit can be set by connecting a resistor between PWR pin and GND. The following table shows the relationship between output power limit and the resistor.

Table. 1 Relationship between R-PWR and power limit

R-PWR	56 KΩ	68 KΩ	82 KΩ	100 KΩ	120 KΩ
Pout(typ.)	38W	31W	26W	21W	18W

The output power limit function helps customer to control the total power delivery of the system. Especially in the application of fast charge, the total power delivery should be same even though the VOUT is different. Due to this function, the output current limit can be different according to different output voltage.

9.1.8 Constant Voltage / Constant Current Mode

SC8112 operates either in CV (constant voltage) mode or CC (constant current) mode and automatically changes from CV to CC smoothly. In CV mode, SC8112 regulates the output voltage. As long as output current limit threshold is reached, SC8112 enters CC mode and the output voltage drops while output current is clamped at the setting values.

SC8112 both monitors the two output ports current limit. In case either of the two outputs current reaches setting current limit, SC8112 enters CC mode.

The current limit can be set by the current sensing resistors by the following equation.



Where, RSNS is the value of current sense resistor.

Usually, the BC1.2 mode limit is set at 2.8A by default with an external sensing resistor RSNS=20m Ω .When the voltage drop cross the sensing resistor gets higher than 54mV, the driver is turned off and in this way, the output current is limited. Table 2 shows some typical RSNS value and output current limit relationship.

Table. 2 Relationship between RSNS and current limit

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RSNS	Output Current Limit
16mΩ	3.50A
20mΩ	2.80A
24mΩ	2.33A
30mΩ	1.86A

9.1.9 Under-Voltage Lockout (UVLO)

The UVLO function protects the chip from operating at insufficient power supply. The chip disables all the function if input voltage in lower than 4.0V and it doesn't start up again until input voltage is higher than 4.2V.

9.1.10 Output Over-Voltage Protection

SC8112 adopts an output over-voltage protection (OVP) with \pm 1% accuracy. When FB pin is connected to GND, in case the output voltage is higher than 5.55V, the buck converter stops switching until OVP status is removed. When FB is connected with two divider resistors, OVP is triggered in case the FB voltage is higher than 110% normal reference voltage.

9.1.11 Short Circuit Protection and Hiccup

The SC8112 integrates a hiccup mode which is triggered once the output voltage is lower than 2V. In hiccup mode, SC8112 periodically stops switching for 500ms and then tries to restart with output current increasing to current limit for 20ms. This protection mode is especially useful when the output is dead-shorted to ground. The average short-circuit current is greatly reduced to alleviate the thermal issue and to protect the converter. Once the short-circuit condition is removed, SC8112 exits hiccup mode and goes back to normal operation.

9.1.12 Over Temperature Protection

The over temperature protection (OTP) prevents the chip from operating at exceedingly high temperatures. When the silicon die temperature exceeds 165 °C, SC8112 is shut down. When the temperature drops below threshold (typically 150°C), the chip is enabled again.

10 Application Information

10.1 Input and Output Capacitor Selection

The input current of the Buck converter is discontinuously and the input capacitor should be carefully selected. At least 30μ F input capacitor is required for small input voltage ripple and stability. The input capacitor can be electrolytic, tantalum or ceramic. MLCC ceramic capacitor has good high frequency filtering with low ESR, above 60 μ F X5R or X7R capacitors with higher voltage rating than operating voltage with margin is recommended. A 10μ F ceramic capacitor must be placed close to IC's VIN pin, to improve the high frequency performance (stability and EMI radiation).

To avoid input hot swapping spike, a low ESR aluminum electrolytic or solid capacitor is recommend to suppress the input voltage spike. Aluminum solid capacitor is highly recommended to improve efficiency.

The input voltage ripple caused by the capacitance can be calculated by:

$$\Delta V_{IN} = \frac{I_{OUT}}{f_{SW} \times C_{IN}} \times \frac{V_{OUT}}{V_{IN}} \times (1 - \frac{V_{OUT}}{V_{IN}})$$

The output capacitor is recommended to be larger than 80μ F.

The output voltage ripple is estimated as the following equation

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_{SW} \times L} \times (R_{ESR} + \frac{1}{8 \times f_{SW} \times C_{OUT}}) \times (1 - \frac{V_{OUT}}{V_{IN}})$$

If electrolytic or tantalum capacitor is used, low ESR capacitor is recommended and 10μ F ceramic capacitor is needed in parallel.

10.2 Inductor Selection

For better power limit regulation, a larger inductance is recommend to make sure the system operates in CCM mode at the max load, especially the max VIN and the max VOUT. The min inductance is calculated as follows:

$$\mathbf{L} \ge \frac{V_{OUT}}{2I_{OUT} \times f_{SW}} \times (1 - \frac{V_{OUT}}{V_{IN}})$$

The inductor DC resistance value (DCR) affects the conduction loss of switching regulator, so around $10m\Omega$ n DCR is recommended for the first selection. If the current is relatively small, high DCR inductor can be selected. But if switch current is high, just like around 10A, then select the lowest DCR inductor as much as possible because $10m\Omega$ DCR also causes 1W power loss.

The inductor saturation current I_{SAT} should be higher than input / output current with sufficient margin.

10.3 PCB Layout Guide

For best performance, PCB layout should be carefully designed to avoid instability, noise and EMI. Minimizing the area of alternating current and voltage loops in the layout helps reduce EMI. For a BUCK converter, the critical loop area is showed in figure 9:

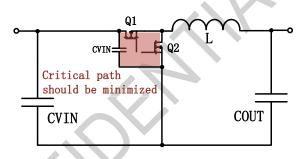


Figure.9 Minimizing the critical path helps mitigate EMI

Here shows some guidelines for reference:

- The input capacitor (CVIN, 10uF, MLCC) should be close to IC to minimize the critical path area and make sure the current flows through the CVIN first, then VIN pin.
- The VCC capacitor (CVCC, 1uF, MLCC) should be close to VCC pin and connected to PGND pin directly, to avoid noise and instability.
- The power limit resistor and line drop compensation resistor (R-PWR) are sensitive, it should be close to the corresponding pin (keep away from switching node) and connected to AGND pin directly.
- The FB feedback resistor should be close to FB pin and be away from switching node. A feed-forward capacitor is highly recommended to prevent instability.
- 5) The current sense traces should be connected to the current sense resistor's pads in Kelvin sense way as below, and routed in parallel (differential routing)

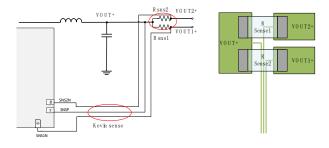


Figure.10 Current sense



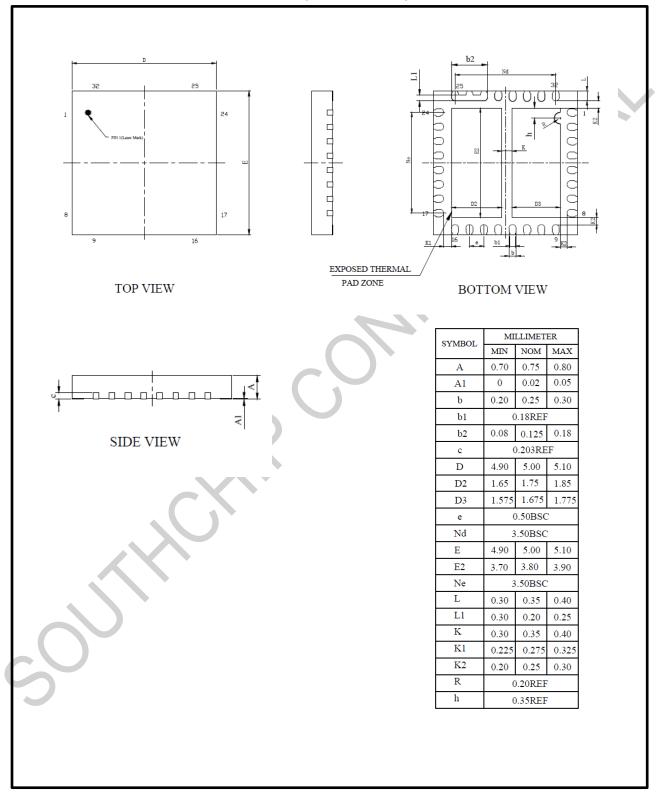
- 6) The RC snubber is connected between SW and PGND to absorb switching noise. The snubber should be close to SW and GND pin and minimize the loop area to optimize EMI.
- 7) The boot capacitor should be close to SW and BOOT pin



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Packaging Information

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